

# Third International Joint Colloquiums on Computer Electronics Electrical Mechanical and Civil - CEMC 2017



Nov 24-25, 2017; Hyderabad, India.  
<http://cenc.theides.org/2017/>



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Third International Joint Colloquiums on Computer Electronics Electrical Mechanical and Civil - CEMC 2017, will be held during Nov 24-25, 2017; Hyderabad, India. CEMC-2017, is to provide an interdisciplinary forum for engineers, researchers and student technocrats to discuss and promote research & technology transfer of advances in Engineering & Technology. The objective of the CEMC 2017 is to enhance scientific and engineering information interchange among researchers, engineers, students and practitioners working in India and rest of the world for promoting research and development activities.

The CEMC 2017 conference is jointly organised by the IDES, ACEECom, AMAE and ACEE. All the accepted registered papers will be published by the Grenze Scientific Society & it will be appear in Grenze Digital Library. All the published papers will be submitted to possible indexing in all the major indexing services like EI, ISI Web of Science, DBLP, IET Inspec, Scopus and etc. Selected, registered & presented papers will be published in the special issue of the following *GREZZE International Journal of Engineering and Technology- GIJET*

CEMC 2017, is an international conference where theory, practices, and applications of Electronic Devices, Digital Electronics, Circuits, Control and Instrumentation, Communication system, Power Electronics and Power Engineering and related topics are presented and discussed. Original contributions are solicited on topics covered under broad areas such as (but not limited to):

## Call for Papers

### Track I: CSE

- Artificial Intelligence
- Compilers and Interpreters
- Computer Architecture & VLSI
- Expert Systems
- User Interface
- Performance Evaluation
- Security & Cryptography
- Image Processing

### Track II: EEE

- Instrumentation
- Electric Power Generation
- Magnetic Theory
- Energy efficiency in industry
- Electronic Materials
- Electrical Machines
- Electric Drivers and Application
- MEMS-Related Technology

### Track III: ME

- Dynamics, Motion Control
- Production Management
- Human-Robot Interfaces
- Mechatronics Design
- Medical Robots and Systems
- Micro Mechatronics
- Operations Research
- Personal and Service Robotics

### Track IV: CE

- Environment and Energy
- Offshore Structures
- Simulation and Modeling
- Structural Engineering
- Uncertainty Models
- Urban Transport System
- Water Resources Engineering
- Structural Integrity

Prospective authors are invited to submit full (original) research papers; which are NOT submitted/published/under consideration anywhere in other conferences/journals; in electronic (Doc or Docx) format through the *CMT Conference Management System* or via email [cenc.chair@gmail.com](mailto:cenc.chair@gmail.com)



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